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SCBS142U-MAY 1992-REVISED OCTOBER 2013

3.3-V ABT 16-Bit Buffers/Drivers With 3-State Outputs

Check for Samples: SN54LVTH16244A, SN74LVTH16244A

FEATURES

- Members of the Texas Instruments Widebus™ **Family**
- State-of-the-Art Advanced BiCMOS Technology (ABT) Design for 3.3-V Operation and Low Static-Power Dissipation
- **Support Mixed-Mode Signal Operation** (5-V Input and Output Voltages With $3.3-V V_{CC}$
- **Support Unregulated Battery Operation** Down to 2.7 V
- Typical V_{OLP} (Output Ground Bounce) $< 0.8 \text{ V at V}_{CC} = 3.3 \text{ V}, T_A = 25^{\circ}\text{C}$
- I_{off} and Power-Up 3-State Support Hot Insertion
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Latch-Up Performance Exceeds 500 mA Per JESD 17
- **ESD Protection Exceeds JESD 22**
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)

DESCRIPTION

The 'LVTH16244A devices are 16-bit buffers and line drivers designed for low-voltage (3.3-V) V_{CC} operation, but with the capability to provide a TTL interface to a 5-V system environment. These devices can be used as four 4-bit buffers, two 8-bit buffers, or one 16-bit buffer. These devices provide true outputs and symmetrical active-low output-enable (\overline{OE}) inputs.

Active bus-hold circuitry holds unused or undriven inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is recommended.

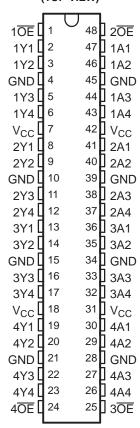
When V_{CC} is between 0 and 1.5 V, the devices are in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 1.5 V, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

These devices are fully specified for hot-insertion applications using Ioff and power-up 3-state. The Ioff circuitry disables the outputs, preventing damaging current backflow through the devices when they are powered down. The power-up 3-state circuitry places the outputs in the high-impedance state during power up and power down, which prevents driver conflict.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet. Widebus is a trademark of Texas Instruments.



SN54LVTH16244A . . . WD PACKAGE SN74LVTH16244A . . . DGG, DGV, OR DL PACKAGE (TOP VIEW)





GQL OR ZQL PACKAGE (TOP VIEW)

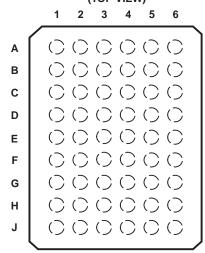
	1	2	3	4	5	6	
Α							1
В	()	()	()	()	()	()	ı
С	()	()	()	()	()	()	ı
D	()	()	()	()	()	()	ı
Е	()	()			()	()	ı
F	()	()			()	()	ı
G	()	()	()	()	()	()	ı
Н	()	()	()	()	()	()	ı
J	()	()	()	()	()	()	ı
K	()	()	()	()	()	()	J

TERMINAL ASSIGNMENTS⁽¹⁾ (56-Ball GQL/ZQL Package)

	1	2	3	4	5	6
Α	1 OE	NC	NC	NC	NC	2 OE
В	1Y2	1Y1	GND	GND	1A1	1A2
С	1Y4	1Y3	V _{CC}	V _{CC}	1A3	1A4
D	2Y2	2Y1	GND	GND	2A1	2A2
E	2Y4	2Y3			2A3	2A4
F	3Y1	3Y2			3A2	3A1
G	3Y3	3Y4	GND	GND	3A4	3A3
Н	4Y1	4Y2	V _{CC}	V _{CC}	4A2	4A1
J	4Y3	4Y4	GND	GND	4A4	4A3
K	4 OE	NC	NC	NC	NC	3 OE

(1) NC - No internal connection

GRD OR ZRD PACKAGE (TOP VIEW)



TERMINAL ASSIGNMENTS⁽¹⁾ (54-Ball GRD/ZRD Package)

•				O ,	
1	2	3	4	5	6
1Y1	NC	1 OE	2 OE	NC	1A1
1Y3	1Y2	NC	NC	1A2	1A3
2Y1	1Y4	V _{CC}	V _{CC}	1A4	2A1
2Y3	2Y2	GND	GND	2A2	2A3
3Y1	2Y4	GND	GND	2A4	3A1
3Y3	3Y2	GND	GND	3A2	3A3
4Y1	3Y4	V _{CC}	V _{CC}	3A4	4A1
4Y3	4Y2	NC	NC	4A2	4A3
4Y4	NC	4 OE	3 OE	NC	4A4
	1Y1 1Y3 2Y1 2Y3 3Y1 3Y3 4Y1 4Y3	1 2 1Y1 NC 1Y3 1Y2 2Y1 1Y4 2Y3 2Y2 3Y1 2Y4 3Y3 3Y2 4Y1 3Y4 4Y3 4Y2	1 2 3 1Y1 NC 1OE 1Y3 1Y2 NC 2Y1 1Y4 V _{CC} 2Y3 2Y2 GND 3Y1 2Y4 GND 3Y3 3Y2 GND 4Y1 3Y4 V _{CC} 4Y3 4Y2 NC	1 2 3 4 1Y1 NC 1OE 2OE 1Y3 1Y2 NC NC 2Y1 1Y4 V _{CC} V _{CC} 2Y3 2Y2 GND GND 3Y1 2Y4 GND GND 3Y3 3Y2 GND GND 4Y1 3Y4 V _{CC} V _{CC} 4Y3 4Y2 NC NC	1 2 3 4 5 1Y1 NC 1OE 2OE NC 1Y3 1Y2 NC NC 1A2 2Y1 1Y4 V _{CC} V _{CC} 1A4 2Y3 2Y2 GND GND 2A2 3Y1 2Y4 GND GND 2A4 3Y3 3Y2 GND GND 3A2 4Y1 3Y4 V _{CC} V _{CC} 3A4 4Y3 4Y2 NC NC 4A2

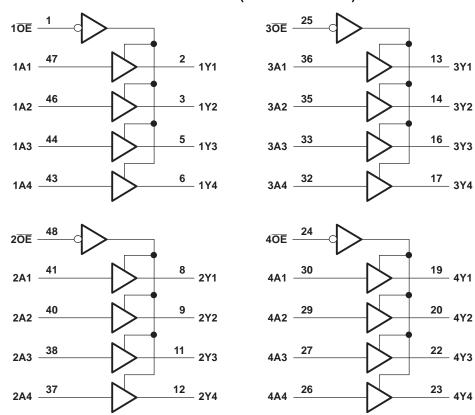
(1) NC - No internal connection



FUNCTION TABLE (EACH 4-BIT BUFFER)

INPL	JTS	OUTPUT
ŌĒ	Α	Υ
L	Н	Н
L	L	L
Н	X	Z

LOGIC DIAGRAM (POSITIVE LOGIC)



Pin numbers shown are for the DGG, DGV, DL, and WD packages.

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ABSOLUTE MAXIMUM RATINGS(1)

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V _{CC}	Supply voltage range		-0.5	4.6	V
VI	Input voltage range ⁽²⁾		-0.5	7	V
Vo	Voltage range applied to any output in the hi	gh-impedance or power-off state (2)	-0.5	7	
Vo	Voltage range applied to any output in the hi	gh state ⁽²⁾	-0.5	V _{CC} + 0.5	V
	Ownered links are a section that the Lawrender	SN54LVTH16244A		96	
l _O	Current into any output in the low state	SN74LVTH16244A		128	V
	(3)	SN54LVTH16244A		48	
I _O	Current into any output in the high state (3)	SN74LVTH16244A		64	V
I _{IK}	Input clamp current	V ₁ < 0		-50	mA
l _{OK}	Output clamp current	V _O < 0		-50	mA
		DGG package		70	
		DGV package		58	
θ_{JA}	Package thermal impedance (4)	DL package		63	°C/W
		GQL/ZQL package		42	
		GRD/ZRD package		36	
T _{stg}	Storage temperature range		-65	150	°C

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

RECOMMENDED OPERATING CONDITIONS(1)

			SN54LVTH	16244A	SN74LVTH	16244A	LINUT
			MIN	MAX	MIN	MAX	UNIT
V _{CC}	Supply voltage		2.7	3.6	2.7	3.6	٧
V _{IH}	High-level input voltage		2		2		V
V _{IL}	Low-level input voltage			0.8		0.8	V
VI	Input voltage			5.5		5.5	V
I _{OH}	High-level output current			-25		-32	mA
I _{OL}	Low-level output current			48		64	mA
Δt/Δν	Input transition rise or fall rate	Outputs enabled		10		10	ns/V
$\Delta t/\Delta V_{CC}$	Power-up ramp rate		200		200		μs/V
T _A	Operating free-air temperature		-55	125	-40	125	°C

⁽¹⁾ All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

Product Folder Links: SN54LVTH16244A SN74LVTH16244A

⁽²⁾ The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

The current flows only when the output is in the high state and $V_O > V_{CC}$.

⁽⁴⁾ The package thermal impedance is calculated in accordance with JESD 51-7.



ELECTRICAL CHARACTERISTICS

over recommended operating free-air temperature range (unless otherwise noted)(1)

PARA	METER	TEST CO	ONDITIONS	SN54L\	/TH162	244A		C to 85° VTH162		–40°	mmended C to 1250 VTH1624	;	UNIT
				MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
V_{IK}		$V_{CC} = 2.7 \text{ V},$ $I_{I} = -18 \text{ mA}$ $V_{CG} = 2.7 \text{ V to } 3.6$				-1.2			-1.2			-1.2	V
		V _{CC} = 2.7 V to 3.6 V,	$I_{OL} = -100 \mu A$	V _{CC} - 0.2			V _{CC} - 0.2			$V_{\text{CC}} - 0.2$			
V_{OH}		$V_{CC} = 2.7 \text{ V},$	$I_{OH} = -8 \text{ mA}$	2.4					2.4			2.4	٧
	V _{CC} = 3 V		$I_{OH} = -24 \text{ mA}$	2									
			$I_{OH} = -32 \text{ mA}$						2			2	
	V _{CC} = 2.7 V		$I_{OL} = 100 \mu A$			0.2			0.2			0.2	
			$I_{OL} = 24 \text{ mA}$			0.5			0.5			0.5	
V_{OL}			$I_{OL} = 16 \text{ mA}$			0.4			0.4			0.4	V
V OL	V _{CC} = 3 V		I _{OL} = 32 mA			0.5			0.5			0.5	V
			$I_{OL} = 48 \text{ mA}$			0.55							
			I _{OL} = 64 mA						0.55			0.55	
		$V_{CC} = 0 \text{ or } 3.6 \text{ V},$	$V_1 = 5.5 V$			50			10			10	
l _l	Control inputs	V _{CC} = 3.6 V,	$V_{I} = V_{CC}$ or GND			±1	±1			±1			μA
	Data	V _{CC} = 3.6 V	$V_I = V_{CC}$			1			1			1	
	inputs	V _{CC} = 3.0 V	$V_I = 0$			-5			- 5			- 5	
l _{off}	_	$V_{CC} = 0$,	V_I or $V_O = 0$ to 4.5 V				±100			±100			μΑ
		V _{CC} = 3 V	$V_1 = 0.8 \text{ V}$	75					75			75	
I _{I(hold)}	Data	ACC - 2 A	V _I = 2 V	- 75					-75			-75	μA
i(noid)	inputs	$V_{CC} = 3.6 V^{(2)},$	$V_{I} = 0 \text{ to } 3.6 \text{ V}$						500 -750			500 -750	•
I _{OZH}		$V_{CC} = 3.6 \text{ V},$	$V_O = 3 V$			5			5			5	μΑ
I _{OZL}		$V_{CC} = 3.6 \text{ V},$	$V_0 = 0.5 V$			– 5			– 5			- 5	μΑ
I _{OZPU}		$\frac{V_{CC}}{OE} = 0 \text{ to } 1.5 \text{ V}, V_{CC}$	$_{0}$ = 0.5 V to 3 V,			±100(3)	±100			±100			μΑ
I _{OZPD}		$V_{CC} = 1.5 \text{ V to } 0, V_{CC}$ $\overline{OE} = \text{don't care}$) = 0.5 V to 3 V,			±100(3)	±100			±100			μΑ
		V _{CC} = 3.6 V,	Outputs high			0.19			0.19			0.19	
I_{CC}		$I_{O}=0$,	Outputs low			5			5			5	mA
		$V_I = V_{CC}$ or GND	Outputs disabled			0.19			0.19			0.19	
ΔI _{CC} ⁽⁴⁾	$V_{CC} = 3 \text{ V to } 3.6 \text{ V}, \text{ One input at } V_{CC}$ Other inputs at V_{CC} or GND					0.2			0.2			0.2	mA
C _i		V _I = 3 V or 0 V			4			4			4		pF
C _o		V _O = 3 V or 0 V			9			9			9		pF

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All typical values are at $V_{CC} = 3.3 \text{ V}$, $T_A = 25^{\circ}\text{C}$. This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.

On products compliant to MIL-PRF-38535, this parameter does not apply.

This is the increase in supply current for each input that is at the specified TTL voltage level, rather than V_{CC} or GND.

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SWITCHING CHARACTERISTICS

over recommended operating free-air temperature, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)⁽¹⁾

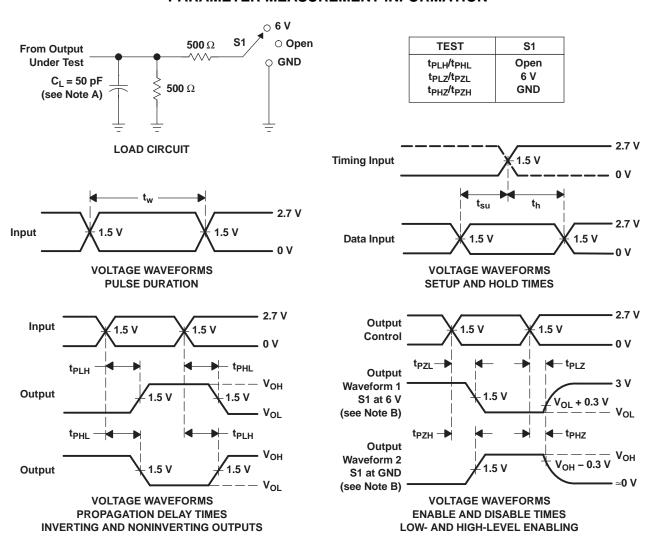
	FROM	то	SN54LVTH16244A				–40°C to 85°C SN74LVTH16244A						-40	commer 0°C to 1 ILVTH1	25C		LIMIT	
PARAMETER	(INPUT)	(OUTPUT)		: 3.3 V .3 V	V _{CC} =	2.7 V		cc = 3.: ± 0.3 \		V _{CC} =	2.7 V		_{CC} = 3.3 ± 0.3 \		V _{CC} =	2.7 V	UNIT	
				MIN	MAX	MIN	MAX	MIN	TYP	MAX	MIN	MAX	MIN	TYP	MAX	MIN	MAX	
t _{PLH}	Α	Υ	1.1	4.4		4.6	1.2	2.3	3.2		3.7	1.2	2.3	4.4		4.6		
t _{PHL}	A	Ť	1.1	3.6		3.9	1.2	2	3.2		3.7	1.2	2	3.6		3.9	ns	
t _{PZH}	- OE	Υ	1.1	4.6		5.4	1.2	2.6	4		5	1.2	2.6	4.6		5.4		
t _{PZL}	OE .	Ť	1.1	5.4		6.2	1.2	2.7	4		5	1.2	2.7	5.4		6.2	ns	
t _{PHZ}	ŌĒ	Υ	1.6	5.7		6.2	2.2	3.3	4.5		5	2.2	3.3	5.7		6.2		
t_{PLZ}	OE .	Ť	1.2	5		4.7	2	3.1	4.2		4.4	2	3.1	5		4.7	ns	
t _{sk(LH)}									0.5					0.5			no	
t _{sk(HL)}									0.5					0.5			ns	

⁽¹⁾ All typical values are at V_{CC} = 3.3 V, T_A = 25°C.

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PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control.
 Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_{O} = 50 Ω , $t_{f} \leq$ 2.5 ns. $t_{f} \leq$ 2.5 ns.
- D. The outputs are measured one at a time, with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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REVISION HISTORY

CI	hanges from Revision T (November 2006) to Revision U	Page
•	Updated document to new TI data sheet format - no specification changes.	1
•	Removed ordering information.	1
•	Updated operating temperature range.	5

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PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish (6)	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
5962-9668501QXA	ACTIVE	CFP	WD	48	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-9668501QX A SNJ54LVTH16244 AWD	Samples
5962-9668501VXA	ACTIVE	CFP	WD	48	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-9668501VX A SNV54LVTH16244 AWD	Samples
74LVTH16244ADGGRE4	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LVTH16244A	Samples
74LVTH16244ADGGRG4	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LVTH16244A	Samples
SN74LVTH16244ADGGR	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LVTH16244A	Samples
SN74LVTH16244ADGVR	ACTIVE	TVSOP	DGV	48	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LL244A	Samples
SN74LVTH16244ADL	ACTIVE	SSOP	DL	48	25	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LVTH16244A	Samples
SN74LVTH16244ADLG4	ACTIVE	SSOP	DL	48	25	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LVTH16244A	Samples
SN74LVTH16244ADLR	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LVTH16244A	Samples
SN74LVTH16244AZQLR	LIFEBUY	BGA MICROSTAR JUNIOR	ZQL	56	1000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	-40 to 85	LL244A	
SN74LVTH16244AZRDR	LIFEBUY	BGA MICROSTAR JUNIOR	ZRD	54	1000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	-40 to 85	LL244A	
SNJ54LVTH16244AWD	ACTIVE	CFP	WD	48	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-9668501QX A SNJ54LVTH16244 AWD	Samples

⁽¹⁾ The marketing status values are defined as follows: **ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

PACKAGE OPTION ADDENDUM



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NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF SN54LVTH16244A, SN54LVTH16244A-SP, SN74LVTH16244A:

Catalog: SN74LVTH16244A, SN54LVTH16244A

Enhanced Product: SN74LVTH16244A-EP, SN74LVTH16244A-EP

Military: SN54LVTH16244A

Space: SN54LVTH16244A-SP

NOTE: Qualified Version Definitions:





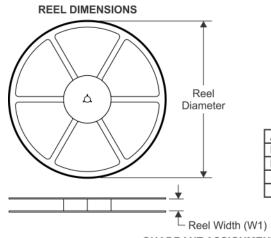
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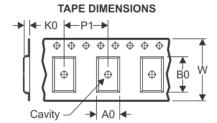
- Catalog TI's standard catalog product
- Enhanced Product Supports Defense, Aerospace and Medical Applications
- Military QML certified for Military and Defense Applications
- Space Radiation tolerant, ceramic packaging and qualified for use in Space-based application

PACKAGE MATERIALS INFORMATION

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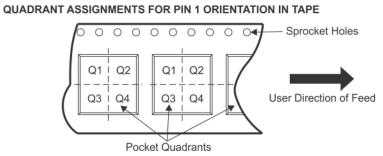
TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
	Dimension designed to accommodate the component length
	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

- Reel Width (WT)



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LVTH16244ADGGR	TSSOP	DGG	48	2000	330.0	24.4	8.6	13.0	1.8	12.0	24.0	Q1
SN74LVTH16244ADGVR	TVSOP	DGV	48	2000	330.0	16.4	7.1	10.2	1.6	12.0	16.0	Q1
SN74LVTH16244ADLR	SSOP	DL	48	1000	330.0	32.4	11.35	16.2	3.1	16.0	32.0	Q1
SN74LVTH16244AZQLR	BGA MI CROSTA R JUNI OR	ZQL	56	1000	330.0	16.4	4.8	7.3	1.5	8.0	16.0	Q1
SN74LVTH16244AZRDR	BGA MI CROSTA R JUNI OR	ZRD	54	1000	330.0	16.4	5.8	8.3	1.55	8.0	16.0	Q1

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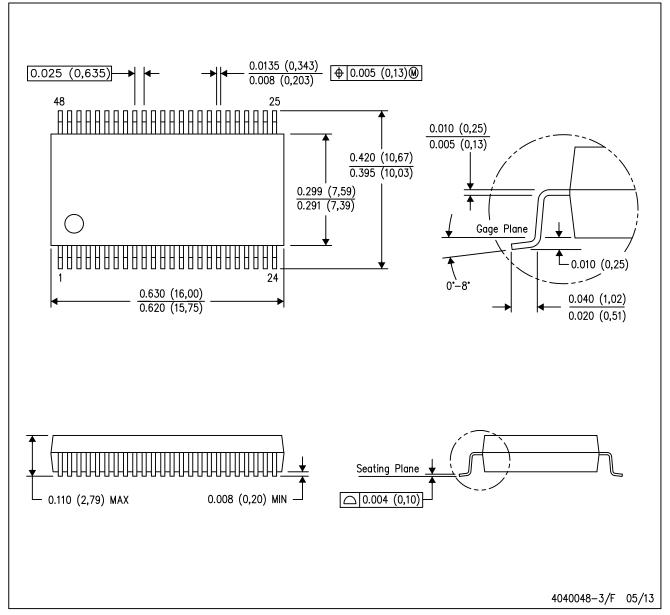


*All dimensions are nomina

All differsions are norminal							
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LVTH16244ADGGR	TSSOP	DGG	48	2000	367.0	367.0	45.0
SN74LVTH16244ADGVR	TVSOP	DGV	48	2000	367.0	367.0	38.0
SN74LVTH16244ADLR	SSOP	DL	48	1000	367.0	367.0	55.0
SN74LVTH16244AZQLR	BGA MICROSTAR JUNIOR	ZQL	56	1000	350.0	350.0	43.0
SN74LVTH16244AZRDR	BGA MICROSTAR JUNIOR	ZRD	54	1000	350.0	350.0	43.0

DL (R-PDSO-G48)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MO-118

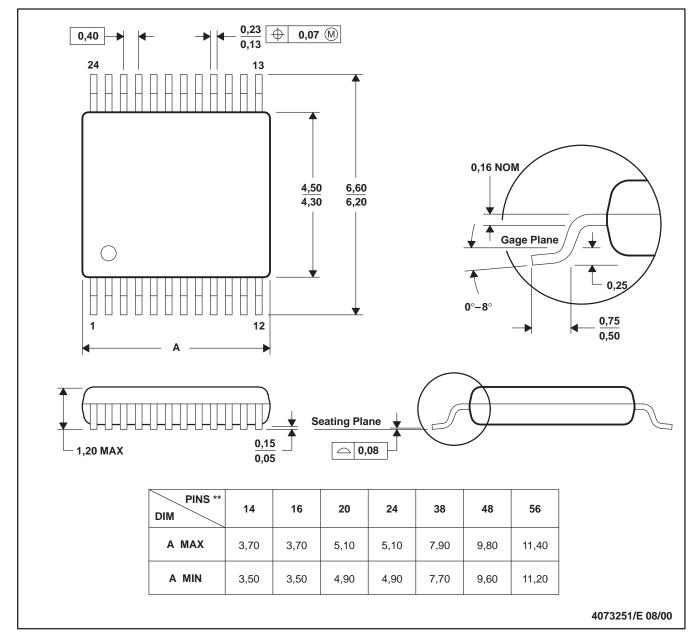
PowerPAD is a trademark of Texas Instruments.



DGV (R-PDSO-G**)

24 PINS SHOWN

PLASTIC SMALL-OUTLINE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

D. Falls within JEDEC: 24/48 Pins – MO-153 14/16/20/56 Pins – MO-194



DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

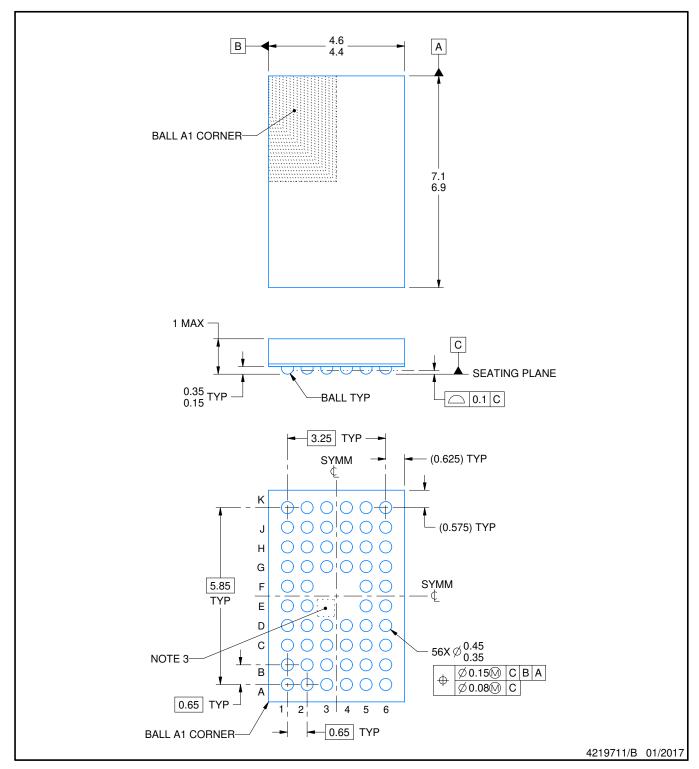
B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153



PLASTIC BALL GRID ARRAY

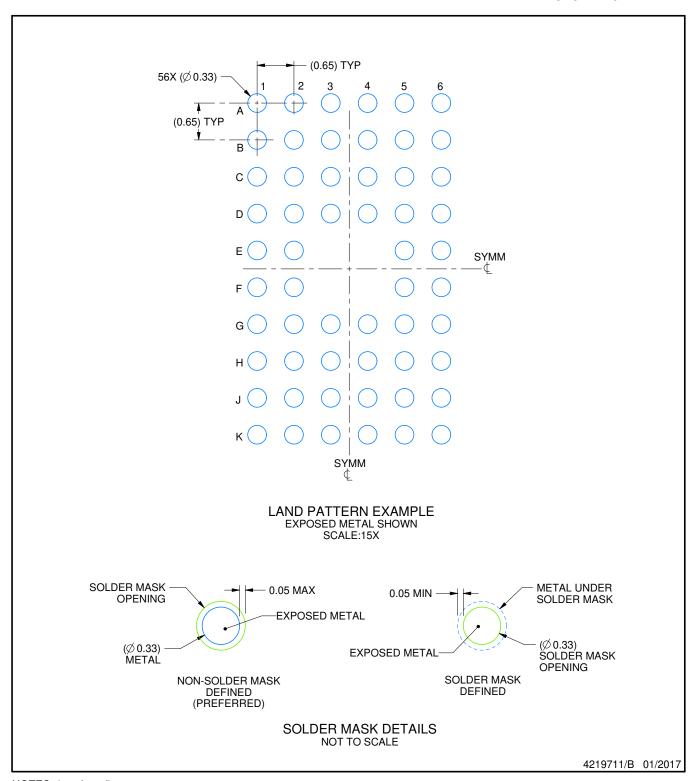


NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
 2. This drawing is subject to change without notice.
 3. No metal in this area, indicates orientation.



PLASTIC BALL GRID ARRAY

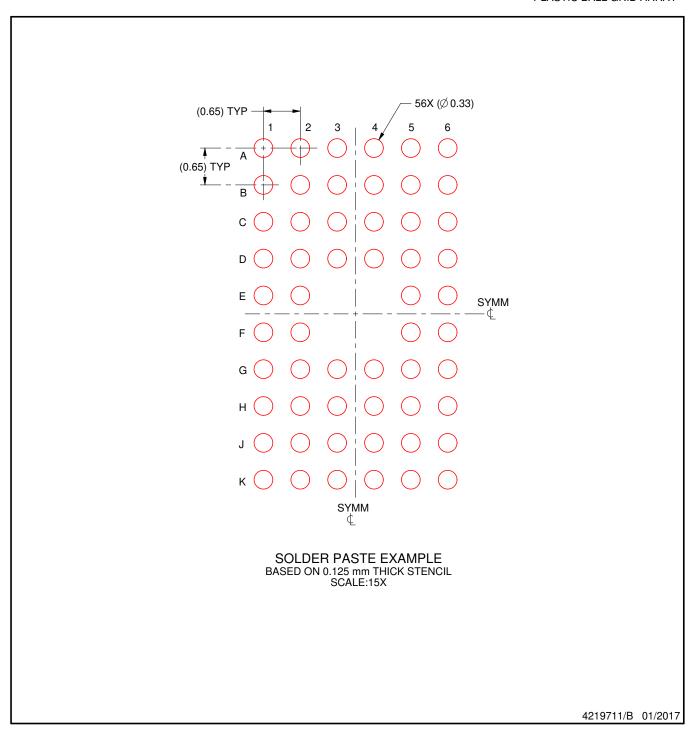


NOTES: (continued)

4. Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints. For information, see Texas Instruments literature number SPRAA99 (www.ti.com/lit/spraa99).



PLASTIC BALL GRID ARRAY



NOTES: (continued)

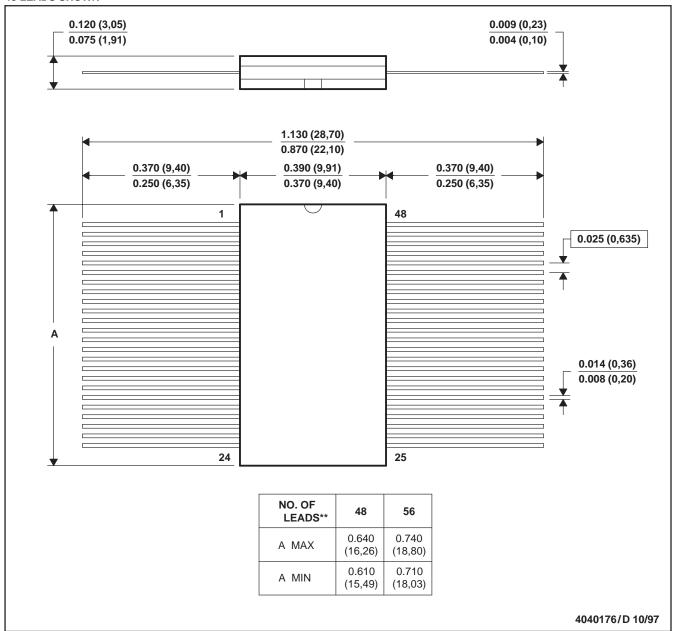
5. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.



WD (R-GDFP-F**)

CERAMIC DUAL FLATPACK

48 LEADS SHOWN



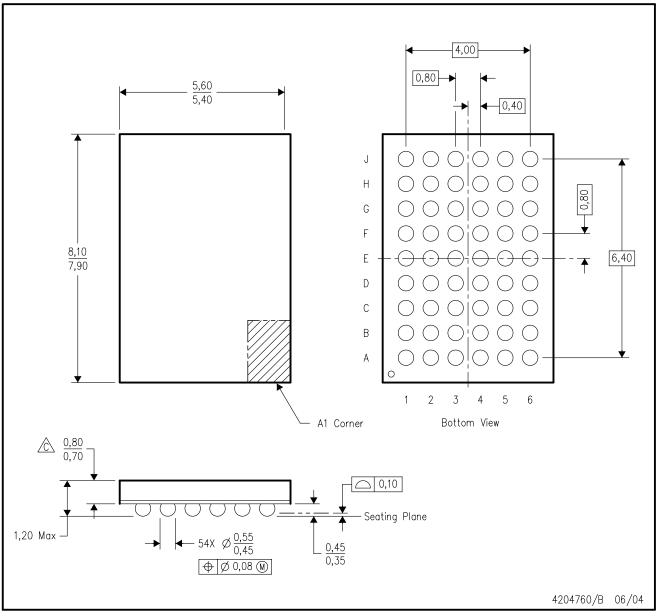
NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only
- E. Falls within MIL STD 1835: GDFP1-F48 and JEDEC MO-146AA

GDFP1-F56 and JEDEC MO-146AB

ZRD (R-PBGA-N54)

PLASTIC BALL GRID ARRAY



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- Falls within JEDEC MO-205 variation DD.
- D. This package is lead-free. Refer to the 54 GRD package (drawing 4204759) for tin-lead (SnPb).



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